SDLS006

D2634, JANUARY 1981 REVISED MARCH 1988

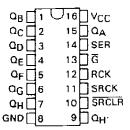
- 8-Bit Serial-In, Parallel-Out Shift Registers with Storage
- Choice of 3-State ('LS595) or Open-Collector ('LS596) Parallel Outputs
- Shift Register Has Direct Clear
- Accurate Shift Frequency: DC to 20 MHz

description

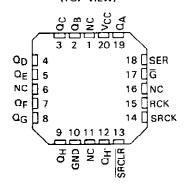
These devices each contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state ('LS595) or open-collector ('LS596) outputs. Separate clocks are provided for both the shift register and the storage register. The shift register has a direct-overriding clear, serial input, and serial output pins for cascading.

Both the shift register and storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register state will always be one clock pulse ahead of the storage register.

SN54LS595, SN54LS596...J OR W PACKAGE SN74LS595, SN74LS596...N PACKAGE (TOP VIEW)

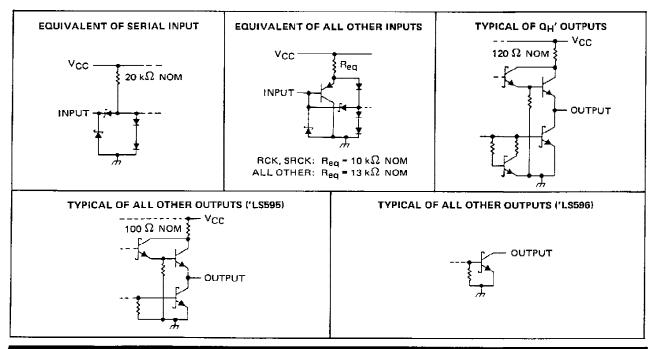


SN54LS595, SN54LS596 . . . FK PACKAGE (TOP VIEW)



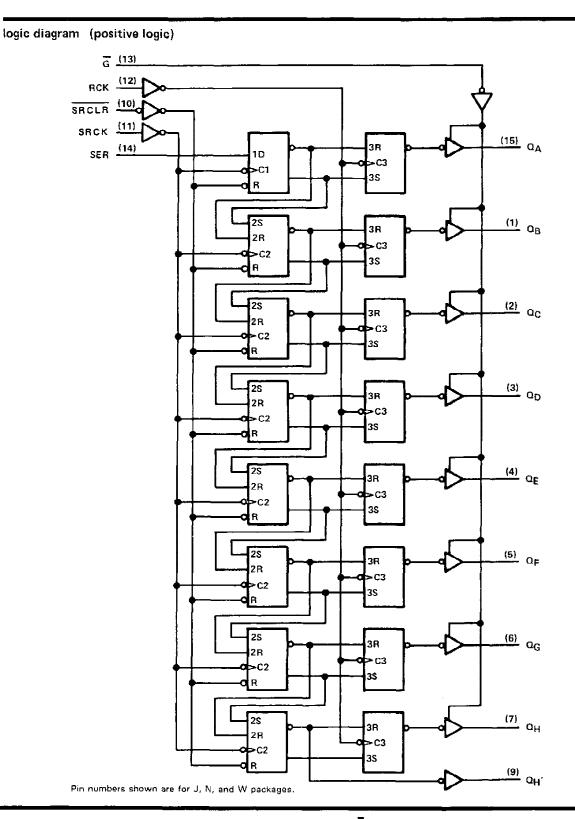
NC - No internal connection

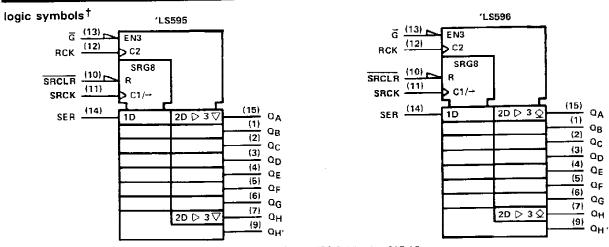
schematics of inputs and outputs



PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.







 $^{^{\}dagger}$ These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, Vcc (see Note 1) | | |
|---------------------------------------|-----------------------|-----------------|
| Input voltage | | |
| Offictate output voltage | | 5.5 V |
| Operation free-air temperature range: | : SN54LS595.SN54LS596 | 55 C to 125 C |
| | SN741 S595, SN74LS596 | 0°C to /0°C |
| Storage temperature range | | – 65°C to 150°C |

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

| | | | | SN54LS | 3' | | SN74LS | s' | UNIT | |
|------------------|--------------------------------|---|------|--------|-----|------|--------|-------|------|--|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | UNI | |
| V _{CC} | Supply voltage | | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | | |
| ViH | High-level input voltage | | 2 | | | 2 | | | V | |
| VIL | Low-level input voltage | | | | 0.7 | | | 0.8 | V | |
| VOH | High-level output voltage | QA thru QH, 'LS596 only | | | 5.5 | | | 5.5 | ٧ | |
| | | QH, | | | -1 | | | - 1 | mA | |
| ¹ОН | High-level output current | Q _A thru Q _H , 'L\$595 only | | | - 1 | | | - 2.6 | | |
| ¹ OL | Low-level output current | OH' | | | 8 | | | 16 | mA | |
| | | Q | | _ | 12 | | | 24 | | |
| fSRCK | Shift clock frequency | 1 | 0 | | 20 | 0 | | 20 | МН | |
| tw(SRCK) | Duration of shift clock pulse | | 25 | | | 25 | | | ns | |
| tw(RCK) | Duration of register clock pul | SE | 20 | | | 20 | | | ns | |
| tw(SRCLR) | Duration of shift clear pulse, | low level | 20 | | | 20 | | | ns | |
| 77,0110 = 111 | | SRCLR inactive before SRCK 1 | 20 | | | 20 | | |] | |
| | | SER before SRCK t | 20 | | | 20 | | | ns | |
| t _{Sti} | Setup time | SRCK † before RCK † (see Note 2) | 40 | | | 40 | | |] | |
| | | SRCLR low before RCK t | 40 | | | 40 | | | | |
| th | Hold time | SER after SRCK † | 0 | | | 0 | | | ns | |
| TA | Operating free-air temperatur | e | - 55 | | 125 | 0 | | 70 | °C | |

NOTE 2: This setup time ensures the register will see stable data from the shift-register outputs. The clocks may be connected together, in which case the storage register state will be one clock pulse behind the shift register.



SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS † | | | SN54LS | ;; | | UNIT | | |
|----------------|------------------|---|----------------------------------|------|--------|-----------------|------|-------|--------------|-------|
| FARA | TAICIEN | I EST CONL | THOMS ' | MIN | TYP# | MAX | MIN | TYP\$ | MAX | OIGIT |
| Vik | | V _{CC} = MIN, I ₁ = - 18 mA | | | | - 1.5 | | | – 1.5 | V |
| | 'LS595 Q | V _{CC} = MIN, V _{IH} = 2 V, | lOH = - 1 mA | 2.4 | 3.2 | | | | | |
| ∨он | | V _{II} = MAX | I _{OH} 2.6 mA | - | | | 2.4 | 3.1 | | V |
| | QH' | | 1 _{OH} = -1 mA | 2.4 | 3.2 | | 2.4 | 3.2 | | |
| IОН | 'L\$596 Q | $V_{CC} = MIN, V_{IH} = 2 V, V_{I}$ | L = MAX, V _{OH} = 5.5 V | | | 0.1 | | | 0.1 | mΑ |
| | α | | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| VOL | | V _{CC} = MIN, V _{IH} = 2 V, | I _{OL} = 24 mA | | | | | 0.35 | 0.5 | v |
| *UL | α _H ′ | VIL = MAX | 10L = 8 mA | | 0.25 | 0.4 | | 0,25 | 0.4 | • |
| | | | I _{QL} ≈ 16 mA | | | | | 0.35 | 0,5 | |
| lozh | 'LS595 Q | VCC = MAX, VIH = 2 V, VI | L = MAX, V _{OH} = 2.7 V | | | 20 | | | 20 | μA |
| IOZL | 'LS595 Q | VCC = MAX, VIH = 2 V, VI | L = MAX, VOH = 0.4 V | | | - 20 | | | - 20 | μА |
| l ₁ | | VCC = MAX, VI = 7 V | | | | 0.1 | | | 0.1 | mA |
| ЧН | | V _{CC} - MAX, V ₁ = 2.7 V | | | | 20 | | | 20 | μА |
| 1 | SER | Vcc = MAX, V1 = 0.4 V | | | | - 0.4 | | | - 0.4 | mΑ |
| 1 L | All others | VCC MAX, V) "GA V | | | | - 0.2 | | | - 0.2 | ,117 |
| les X | 'LS595 Q | V _{CC} = MAX, V _C = 0 V | | - 30 | | 130 | - 30 | | - 130 | mA |
| los § | Q _H ′ | VCC - WAX, VO - 0 V | | - 20 | | - 20 - 100 - 20 | | - 100 | mA | |
| lance | 'LS595 | - | | | 33 | 50 | | 33 | 50 | _ ^ |
| ICCH | 'LS596 | V _{CC} = MAX, | | | 30 | 45 | | 30 | 45 | mA |
| loo | 'LS595 | All possible inputs grounded, | | _ | 42 | 65 | | 42 | 65 | |
| CCL | 'LS596 | All outputs open | | 36 | 55 | | 36 | 55 | mA | |
| ¹ccz | 'L S 595 | | | | 44 | 65 | | 44 | 65 | mΑ |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

SN54LS595, SN54LS596, SN74LS595, SN74LS596 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

switching characteristics, VCC = 5 V, TA = 25° C (see note 3)

| DADAMETER | FROM | то | TEST ODA | DITIONS | | 'LS595 | ; | 'LS596 | | | UNIT |
|------------------|------------|------------------------------------|-------------------------|------------------------|-----|--------|-----|--------|-----|------|------|
| PARAMETER | (INPUT) | (OUTPUT) | TEST CON | MIN | TYP | MAX | MIN | TYP | MAX | UNII | |
| tPLH | SRCK1 | | 5 46 | 0 - 00 - 5 | | 12 | 18 | | 14 | 21 | ns |
| ^t PHL | SHUKT | QH' | R _L = 1kΩ, | C _L = 30 pF | | 17 | 25 | | 20 | 30 | ns |
| ^t PLH | RCK 1 | Q _A thru Q _H | | C _L = 45 pF | 1 | 12 | 18 | | 28 | 42 | ns |
| ^t PHL | , nck ' | L CA IIII CH | R _L = 667 Ω, | | | 24 | 35 | | 24 | 35 | ns |
| tPZH | Ğ↓ | Q _A thru Q _H | | | | 20 | 30 | | | | ns |
| tPZL | 1 3 . | QA thru QH | | | | 25 | 38 | | | | ns |
| ^t PHZ | <u>G</u> ↑ | Q _A thru Q _H | $R_1 = 667 \Omega$. | CL = 5 pF | | 20 | 30 | | | | ns |
| tPLZ | 1 3 ' | QA INTO CH | UL - 601 71, | | | 25 | 38 | | | | ns |
| tPLH . | Ğ١ | Qд thru Qн | $R_1 = 667 \Omega_s$ | C. = 45 oF | | | · | | 40 | 60 | ns |
| tPHL | Ğ∔ | Q _A thru Q _H | ME - 007 12, | C _L = 45 pF | | | | | 25 | 38 | ns |
| ^t PHL | SRCLR + | QH' | $R_{L} = 1 k\Omega$, | CL = 30 pF | | 24 | 35 | | 24 | 35 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------------|---------|
| 5962-8671701EA | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701EA SNJ54LS595J | Samples |
| 5962-8671701FA | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701FA SNJ54LS595W | Samples |
| 5962-8671701FA | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701FA SNJ54LS595W | Samples |
| SN54LS595J | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS595J | Samples |
| SN54LS595J | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54LS595J | Samples |
| SN74LS595DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS595 | Samples |
| SN74LS595DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS595 | Samples |
| SN74LS595N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS595N | Samples |
| SN74LS595N | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS595N | Samples |
| SNJ54LS595J | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701EA SNJ54LS595J | Samples |
| SNJ54LS595J | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701EA SNJ54LS595J | Samples |
| SNJ54LS595W | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701FA SNJ54LS595W | Samples |
| SNJ54LS595W | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8671701FA SNJ54LS595W | Samples |

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

PACKAGE OPTION ADDENDUM

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(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS595, SN74LS595:

Catalog: SN74LS595

Military: SN54LS595

NOTE: Qualified Version Definitions:

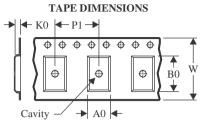
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | U | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LS595DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |

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*All dimensions are nominal

| | Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | |
|---|-------------|--------------|-----------------|------|------|-------------|------------|-------------|--|
| ı | SN74LS595DR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 | |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-8671701FA | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |
| SN74LS595N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS595N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54LS595W | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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